PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
SUMEET C. PANDEY	04/23/2018
GURTEJ S. SANDHU	08/23/2018

RECEIVING PARTY DATA

Name:	MICRON TECHNOLOGY, INC.
Street Address:	8000 SOUTH FEDERAL WAY
Internal Address:	MS 1-525
City:	BOISE
State/Country:	IDAHO
Postal Code:	83716

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	16112333

CORRESPONDENCE DATA

Fax Number: (509)838-3424

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Email: docketing@wellsstjohn.com WELLS ST. JOHN, P.S. **Correspondent Name:** Address Line 1: 601 W. MAIN AVENUE

Address Line 2: SUITE 600

Address Line 4: SPOKANE, WASHINGTON 99201

ATTORNEY DOCKET NUMBER:	MI22-6483	
NAME OF SUBMITTER:	CHERYL A. THOMPSON	
SIGNATURE:	/Cheryl A. Thompson/	
DATE SIGNED:	08/24/2018	

Total Attachments: 5

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> **PATENT REEL: 046700 FRAME: 0973**

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PATENT REEL: 046700 FRAME: 0974 **ASSIGNMENT**

<u>PARTIES TO THE ASSIGNMENT</u>:

INVENTORS:

Sumeet C. Pandey 7918 S. Red Cliff Boise, ID 83716

United States

Gurtej S. Sandhu 2964 E. Parkriver Drive

Boise, ID 83706

United States

ASSIGNEE:

Micron Technology, Inc.

MS 1-525

8000 South Federal Way

Boise, ID 83716

United States

BACKGROUND OF THIS ASSIGNMENT:

Inventors have conceived certain new and useful inventions disclosed

in a United States patent application titled Integrated Assemblies Having

Metal-Containing Regions Coupled with Semiconductor Regions.

Micron Technology, Inc. (hereinafter referred to as "ASSIGNEE")

desires to acquire the entire right, title and interest in said inventions and

with respect to any Letters Patent that may be granted with respect to the

inventions in both the United States and in all foreign countries.

MI22-6483 P231_Apr_18,_2018_423987.doc 1 of 5

PATENT REEL: 046700 FRAME: 0975 THE PARTIES AGREE AS FOLLOWS:

In consideration of good and valuable consideration, the receipt,

sufficiency and adequacy of which is hereby acknowledged, INVENTORS

have sold, assigned and transferred, and by these present do hereby sell,

assign and transfer to ASSIGNEE the entire right, title and interest in the

above-identified inventions and patent application(s) and to any reissues,

renewals, divisions or continuations of the application(s) thereof, and hereby

authorizes the Commissioner of Patents and Trademarks to issue such

Letters Patent(s) to ASSIGNEE for the sole use of ASSIGNEE, its

successors or assigns.

INVENTORS further agree to execute, at the request and expense of

ASSIGNEE, such other formal documents as may be required to fully convey

the interest transferred herein and will similarly execute any patent

application papers (foreign or domestic) required for the filing of any

divisional, continuation, renewal or reissue of the patent application(s) or

resulting Letters Patent(s); and will generally do everything necessary or

desirable to obtain and enforce proper protection for the inventions assigned

hereby.

INVENTORS further assign to ASSIGNEE the whole right, title and

interest in the inventions disclosed in the application(s) throughout all

countries foreign to the United States. ASSIGNEE is hereby authorized to

apply for patents relating to the inventions in its own name in countries

where such procedure is proper; to claim the benefit of the International

2 of 5

REEL: 046700 FRAME: 0976

inventions under the Patent Cooperation Treaty; and to file and prosecute applications relating to the inventions under the European Patent Convention. INVENTORS agree to execute application(s) relating to the inventions in those countries and under those conventions where it is necessary that the same be executed by the inventor, and to execute assignments of such applications and the resulting Letters Patent(s) to ASSIGNEE as well as all other necessary papers in relation to such applications and Letters Patent(s). INVENTORS hereby consent that a copy

Convention; to file and prosecute International Applications relating to the

of this assignment shall be deemed a full legal and formal equivalent of any

document which may be required in any country as proof of the right of

ASSIGNEE to apply for patent and other form of protection for said

inventions and to claim the aforesaid benefit of the right of priority.

To be binding on the heirs, assigns, representatives and successors of the undersigned and extend to the successors, assigns and nominees of the

Assignee.

3 of 5

Dated: 04 23 2018	Signature:	Sumeet D. Pandey
State of <u>IDAHO</u>)	
County of AOA) ss.	
on this 23 rd day of me, <u>Sarak M. Rekalleza</u>	April	, 20 18, before
Official), personally appeared Sum		
(or proved to me on the basis of		•
whose name is subscribed within that he/she executed the Assignment	**	•
by his/her signature on the		• • •
Assignment.	- Amin's	,
*		au Bloken
SEAL STORY		
	My Coi	mmission Expires: <u>७//७/२</u> ०३

Dated: August 23 2018 Signature: Gurlei S. Sandhu

MI22-6483 P231_Apr_18,_2018_423987.doc

RECORDED: 08/24/2018

5 of 5